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APR 11 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant: Leonel R. Arana et al.
Serial No.: 10/807,836
Filed: March 24, 2004
For: Microfabricated Hot Wire Vacuum Sensor

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Art Unit: 2813
Examiner: Heather Anne Doty
Docket: ITL 1133US P19113
Assignee: Intel Corporation

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO FINAL REJECTION

Sir:

In response to the final rejection mailed March 20, 2006, please amend the above-referenced patent application as follows:

OK to enter. H. Doty 4/17/06

Date of Deposit: April 11, 2006
I hereby certify that this document is being facsimile transmitted to the United States Patent and Trademark Office (Fax No. 571/273-8300) on the date indicated above.
Cynthia L. Hayden
Cynthia L. Hayden